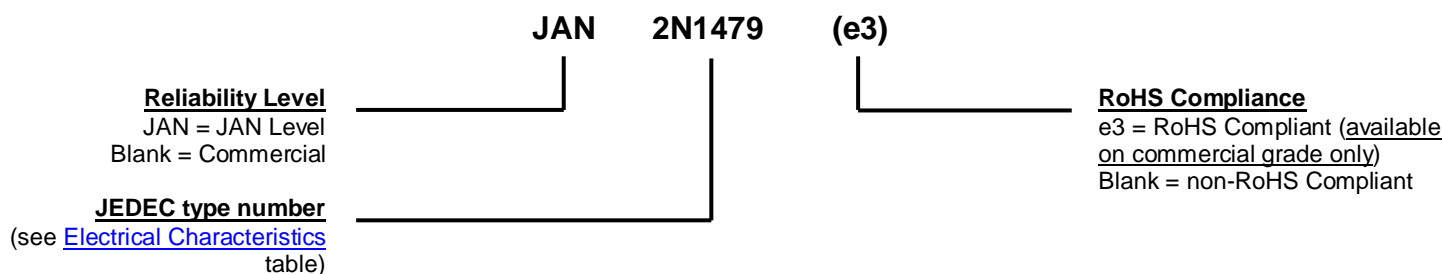


**MECHANICAL and PACKAGING**

- CASE: Hermetically sealed steel base, nickel cap
- TERMINALS: Leads are gold plated kovar (Solder dip (Sn63/Pb37) is available upon special request. NOTE: Solder dipping will eliminate RoHS compliance.)
- MARKING: Part number, date code, manufacturer's ID
- POLARITY: NPN
- WEIGHT: Approximately 1.14 grams
- See [Package Dimensions](#) on last page.

**PART NOMENCLATURE**

**SYMBOLS & DEFINITIONS**

Symbol	Definition
$h_{FE}$	Common-emitter static forward current transfer ratio: The ratio of the dc output current to the dc input current with the output voltage held constant.
$I_B$	Base current: The value of the dc current into the base terminal.
$I_C$	Collector current: The value of the dc current into the collector terminal.
$I_E$	Emitter current: The value of the dc current into the emitter terminal.
$T_C$	Case temperature: The temperature measured at a specified location on the case of a device.
$V_{(BR)CEO}$	Collector-emitter breakdown voltage, base open. The breakdown voltage between the collector and emitter terminals when the collector terminal is biased in the reverse direction with respect to the emitter terminal, and the base terminal is open circuited. The collector terminal is considered to be biased in the reverse direction when it is made positive for npn transistors, or negative for pnp transistors, with respect to the emitter terminal.
$V_{CB}$	Collector-base voltage: The dc voltage between the collector and the base.
$V_{CBO}$	Collector-base voltage, emitter open: The voltage between the collector and base terminals when the emitter terminal is open-circuited.
$V_{CC}$	Collector-supply voltage: The supply voltage applied to a circuit connected to the collector.
$V_{CE}$	Collector-emitter voltage: The dc voltage between the collector and the emitter.
$V_{CE(sat)}$	Collector-emitter saturation voltage: The voltage between the collector and emitter terminals under conditions of base current or base-emitter voltage beyond which the collector current remains essentially constant as the base current or voltage is increased.
$V_{CEO}$	Collector-emitter voltage, base open: The voltage between the collector and the emitter terminals when the base terminal is open-circuited.
$V_{EB}$	Emitter-base voltage: The dc voltage between the emitter and the base
$V_{EBO}$	Emitter-base voltage, collector open: The voltage between the emitter and base terminals with the collector terminal open-circuited.

**ELECTRICAL CHARACTERISTICS @  $T_A = +25^\circ\text{C}$ , unless otherwise noted**
**OFF CHARACTERISTICS**

Parameters / Test Conditions	Symbol	Min.	Max.	Unit
Collector-Emitter Breakdown Voltage $I_C = 50\text{ mA}$ , 2N1479, 2N1481 2N1480, 2N1482	$V_{(BR)CEO}$	40 55		V
Collector-Emitter Breakdown Voltage $V_{EB} = 1.5\text{ V}$ , $I_C = 0.25\text{ mA}$ $V_{EB} = 1.5\text{ V}$ , $I_C = 0.25\text{ mA}$ 2N1479, 2N1481 2N1480, 2N1482	$V_{(BR)CEX}$	60 100		V
Collector-Base Cutoff Current $V_{CB} = 30\text{ V}$ $V_{CB} = 50\text{ V}$ 2N1479, 2N1481 2N1480, 2N1482	$I_{CBO1}$		5.0	$\mu\text{A}$
Emitter-Base Cutoff Current $V_{EB} = 12\text{ V}$	$I_{EBO}$		10	$\mu\text{A}$

**ON CHARACTERISTICS**

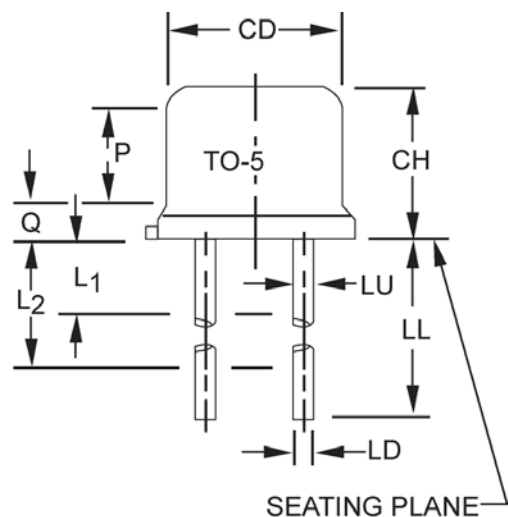
Parameters / Test Conditions	Symbol	Min.	Max.	Unit
Forward-Current Transfer Ratio $I_C = 200\text{ mA}$ , $V_{CE} = 4.0\text{ V}$ 2N1479, 2N1480 2N1481, 2N1482	$h_{FE}$	20 35	60 100	
Collector-Emitter Saturation Voltage $I_C = 200\text{ mA}$ , $I_B = 20\text{ mA}$ $I_C = 200\text{ mA}$ , $I_B = 10\text{ mA}$ 2N1479, 2N1480 2N1481, 2N1482	$V_{CE(sat)}$		0.75 0.75	V
Base-Emitter Voltage Non-Saturation $I_C = 200\text{ mA}$ , $V_{CE} = 4.0\text{ V}$	$V_{BE}$		1.5	V

**DYNAMIC CHARACTERISTICS**

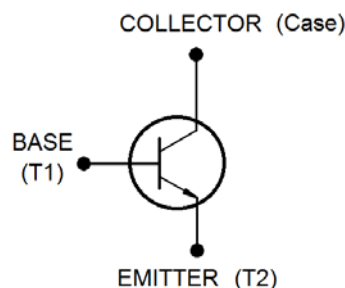
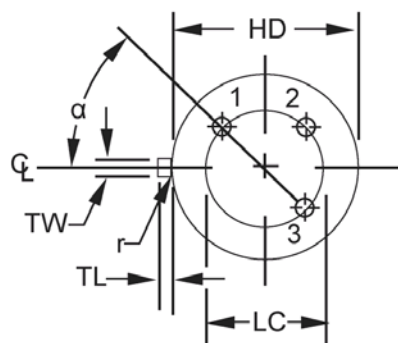
Parameters / Test Conditions	Symbol	Min.	Max.	Unit
Forward Current Cutoff Frequency $I_C = 5.0\text{ mA}$ , $V_{CB} = 28\text{ V}$	$f_{ab}$	800		kHz

**SWITCHING CHARACTERISTICS**

Parameters / Test Conditions	Symbol	Min.	Max.	Unit
Turn-On / Turn-Off Time $V_{CC} = 12\text{ V}$ , $R_C = 59\ \Omega$ , $I_{B0} = I_{B2} = 8.5\text{ mA}$ ; $I_{B1} = 20\text{ mA}$	$t_{on} + t_{off}$		25	$\mu\text{s}$

**PACKAGE DIMENSIONS**


Symbol	Dimensions				Note
	Inch		Millimeters		
	Min	Max	Min	Max	
CD	0.305	0.335	7.75	8.51	
CH	0.240	0.260	6.10	6.60	
HD	0.335	0.370	8.51	9.40	
LC	0.200 TP		5.08 TP		10
LD	0.016	0.021	0.41	0.53	2, 9
LL	1.5	1.75	3.81	4.45	9
LU	0.016	0.019	0.41	0.48	3, 9
L1	-	0.050	-	1.27	13
L2	0.250	-	6.35	-	13
P	0.100	-	2.54	-	4
Q	-	-	-	-	5
TL	0.029	0.045	0.74	1.14	8
TW	0.028	0.034	0.71	0.86	
r	-	0.007	-	0.18	Radius
α	45° TP		45° TP		6


**NOTES:**

1. Dimensions are in inches. Millimeters are given for information only.
2. Measure in the zone beyond 0.250 (6.35 mm) from the seating plane.
3. Measure in the zone 0.050 (1.27 mm) and 0.250 (6.35 mm) from the seating plane.
4. Variations on Dim B in this zone shall not exceed 0.010 (0.25 mm).
5. Outline in this zone is not controlled.
6. When measured in a gauging plane 0.054 + 0.001 (1.37 mm + 0.03 mm) below the seating plane of the transistor max dia leads shall be within 0.007 (0.18mm) of their true location relative to a maximum width tab. Smaller dia leads shall fall within the outline of the max dia lead tolerance.
7. Collector internally connected to case.
8. Measured from the maximum diameter of the actual device.
9. All 3 leads.
10. Leads at gauge plane 0.054 inch (1.37 mm) +0.001 inch (0.03 mm) -0.000 inch (0.00 mm) below seating plane shall be within 0.007 inch (0.18 mm) radius of true position (TP) relative to tab. Device may be measured by direct methods or by gauge.